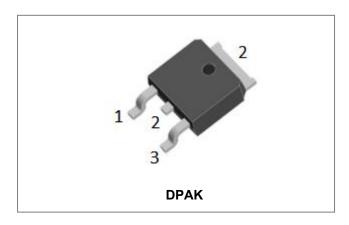






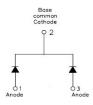
MBRD1045CT SCHOTTKY RECTIFIER



Features

- 150°C T_J operation
- Center tap configuration
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- "-A" is an AEC-Q101 qualified device
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	-	45	V
Average Rectified Forward Current	I _{F (AV)}	50% duty cycle @T _C =102°C, rectangular wave form 5(per leg) 10(per device)		Α
Peak One Cycle Non-Repetitive Surge Current(per leg)	I _{FSM}	8.3 ms, half Sine pulse	125	Α

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop(per leg) *	V _{F1}	@ 5A, Pulse, T _J = 25 °C	0.53	0.55	V
Reverse Current (per leg) *	I _{R1}	@V _R = rated V _R , T _J = 25 °C	0.011	0.2	mA
Junction Capacitance(per leg)	Ст	@V _R = 5V, T _C = 25 °C, f _{SIG} = 1MHz	248	300	pF

^{*} Pulse width < 300 µs, duty cycle < 2%



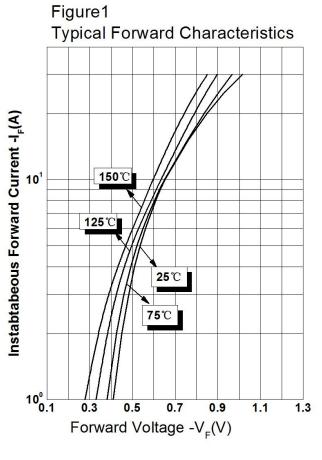


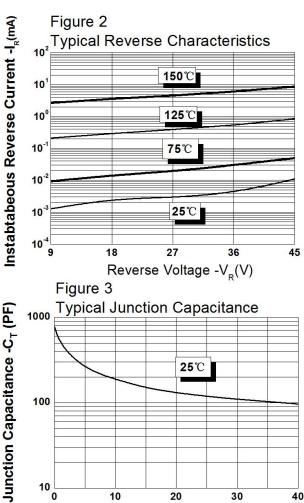


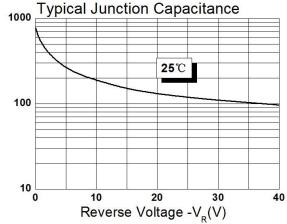
Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Condition Specification	
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T _{stg}	-	-55 to + 150	°C
Thermal Resistance Junction to Case	Rejc	-	6	°C/W
Approximate Weight	wt	-	0.39	g
Case Style	DPAK			

Ratings and Characteristics Curves







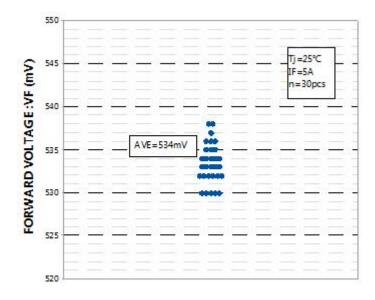
[•] China - Germany - Korea - Singapore - United States •

[•] http://www.smc-diodes.com - sales@ smc-diodes.com •









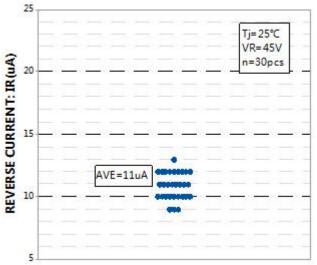


Fig.4-VF DISPERSION MAP

Fig.5-IR DISPERSION MAP

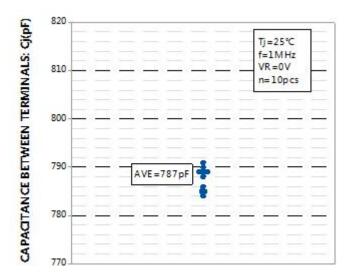


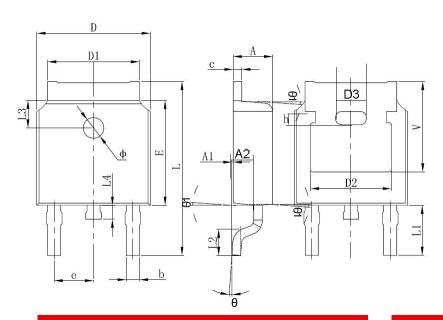
Fig.6-Cj DISPERSION MAP







Mechanical Dimensions DPAK



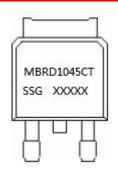
SYMBOL	Millimeters		Inches	
STMBOL	Min.	Max.	Min.	Max.
Α	2.20	2.40	0.087	0.094
A1	0.00	0.127	0.000	0.005
b	0.66	0.86	0.026	0.034
С	0.46	0.60	0.018	0.024
D	6.50	6.70	0.256	0.264
D1	5.13	5.46	0.202	0.215
D2	4.83	REF.	0.190 REF.	
E	6.00	6.20	0.236	0.244
е	2.186	2.386	0.086	0.094
L	9.70	10.40	0.381	0.409
L1	2.90 REF.		0.144 REF.	
L2	1.40	1.70	0.055	0.067
L3	1.60 REF.		0.063 REF.	
L4	0.60	1.00	0.024	0.039
Ф	1.10	1.30	0.043	0.051
Θ	0°	8°	0°	8°
h	0.00	0.30	0.000	0.012
V	5.35 REF.		0.211	REF.

Ordering Information

Device	Package	Shipping
MBRD1045CT	DPAK (Pb-Free)	2500pcs / reel
MBRD1045CTTR	DPAK (Pb-Free)	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel Packaging specification.

Marking Diagram



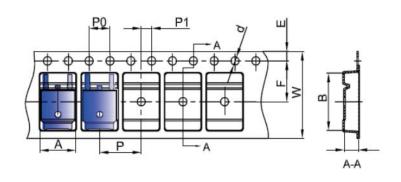
Where XXXXX is YYWWL

MBR = Device Type
D = Package type
10 = Forward Current (10A)
45 = Reverse Voltage (45V)
CT = Configuration
SSG = SSG
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin

Epoxy resin UL:94V-0

Carrier Tape Specification DPAK



SYMBOL	Millimeters		
STWIDOL	Min.	Max.	
Α	6.80	7.00	
В	10.40	10.60	
С	2.60	2.80	
d	Ф1.45	Ф1.65	
E	1.65	1.85	
F	7.40	7.60	
P0	3.90	4.10	
Р	7.90	8.10	
P1	1.90	2.10	
W	15.90	16.30	

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MBRD1045CT



Technical Data Data Sheet N2020, Rev. -





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